

Electronic Patent Application Fee Transmittal

Application Number:	10625452			
Filing Date:	23-Jul-2003			
Title of Invention:	Methods of forming semiconductor devices using an etch stop layer			
First Named Inventor/Applicant Name:	Kwang-Ok Koh			
Filer:	David Moore/Amelia Tauchen			
Attorney Docket Number:	5649-1144			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				
Extension - 3 months with \$0 paid	1253	1	1020	1020

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				1020